

## N-Channel Enhancement Mode Power MOSFET

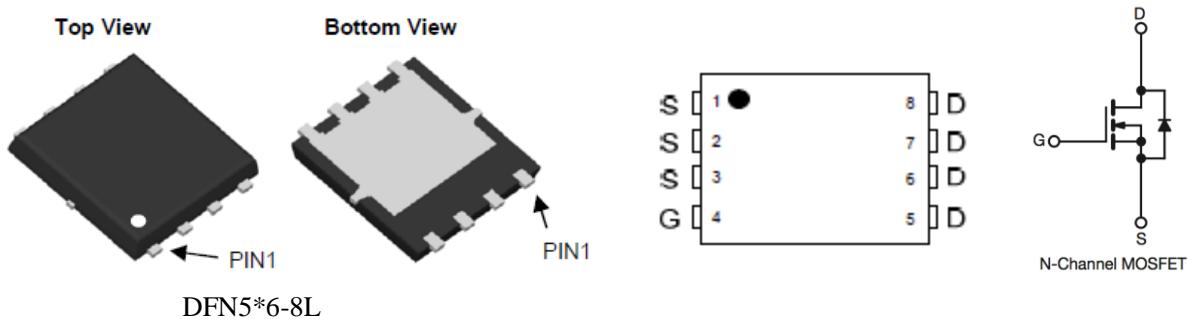
### ● Features

$V_{DS} = 30V$ ,  
 $I_D = 83.5A$   
 $R_{DS(ON)} @ V_{GS} = 10V, TYP 2.5m\Omega$   
 $R_{DS(ON)} @ V_{GS} = 4.5V, TYP 3.3m\Omega$

### ● General Description

- Synchronous Rectification in DC/DC and AC/DC Converters
- Industrial and Motor Drive applications

### ● Pin Configurations



### ● Absolute Maximum Ratings @ $T_A=25^\circ C$ unless otherwise noted

Parameter		Symbol	Ratings	Unit
Drain-Source Voltage		$V_{DSS}$	30	V
Gate-Source Voltage		$V_{GSS}$	$\pm 20$	V
Drain Current (Continuous) *AC	$T_c=25^\circ C$	$I_D$	83.5	A
	$T_c=70^\circ C$		66	
Drain Current (Pulse) *B		$I_{DM}$	205	A
Power Dissipation	$T_c=25^\circ C$	$P_D$	36	W
Operating Temperature/ Storage Temperature		$T_J/T_{STG}$	-55~150	°C

### ● Thermal Resistance Ratings

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient	$t \leq 10 s$	$R_{thJA}$	18	22	°C/W
Maximum Junction-to-Case (Drain)	Steady State	$R_{thJC}$	2.8	3.5	

● **Electrical Characteristics** @ $T_A=25^\circ C$  unless otherwise noted

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30	--	--	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 30V, V_{GS} = 0V$	--	--	1	$\mu A$
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_{DS} = 250\mu A$	1	1.6	3	V
Gate Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$	--	--	$\pm 100$	nA
Drain-Source On-state Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 20A$	--	2.5	3.3	$m\Omega$
	$R_{DS(on)}$	$V_{GS} = 4.5V, I_D = 10A$	--	3.3	4.3	$m\Omega$
Diode Forward Voltage	$V_{SD}$	$I_{SD} = 1A, V_{GS} = 0V$	--	0.78	1.2	V
Diode Forward Current *AC	$I_S$	$T_C = 25^\circ C$	--	--	46	A
<b>Switching</b>						
Total Gate Charge	$Q_g$	$V_{DS}=15V, I_D=60A,$ $V_{GS}=10V$	--	63	--	nC
Gate-Source Charge	$Q_{gs}$		--	10	--	nC
Gate-Drain Charge	$Q_{gd}$		--	9.5	--	nC
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=15V, I_D=60A$ $V_{GS}=10V, R_G=1.6\Omega$	--	9	--	ns
Turn-on Rise Time	$t_r$		--	4	--	ns
Turn-off Delay Time	$t_{d(off)}$		--	44	--	ns
Turn-Off Fall Time	$t_f$		--	7	--	ns
<b>Dynamic</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=15V, V_{GS}=0V, f=1.0MHz$	--	3550	--	pF
Output Capacitance	$C_{oss}$		--	950	--	pF
Reverse Transfer Capacitance	$C_{rss}$		--	63	--	pF

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ C$ . The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C: The current rating is based on the  $t \leq 10s$  junction to ambient thermal resistance rating.

- **Typical Performance Characteristics ((T<sub>J</sub> = 25 °C, unless otherwise noted))**

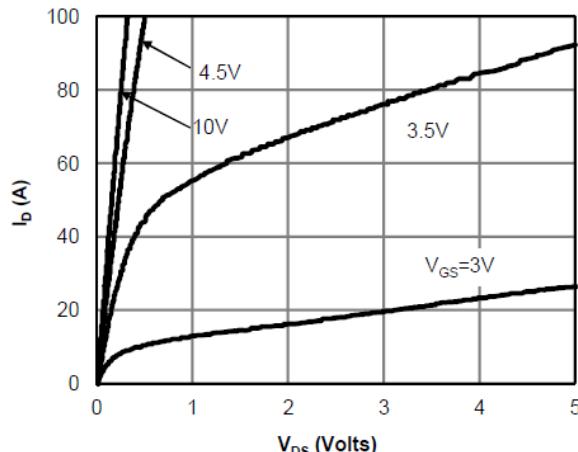


Figure 1: On-Region Characteristics

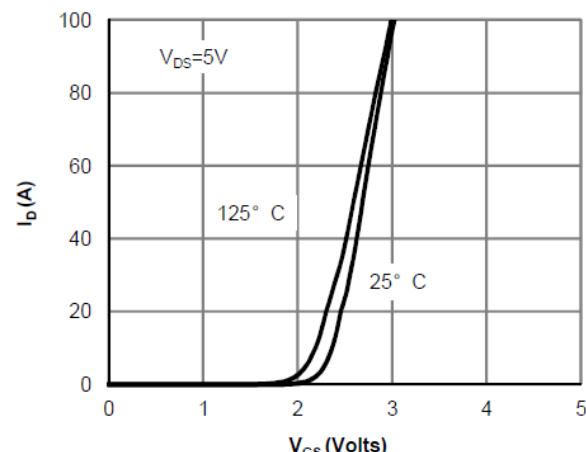


Figure 2: Transfer Characteristics

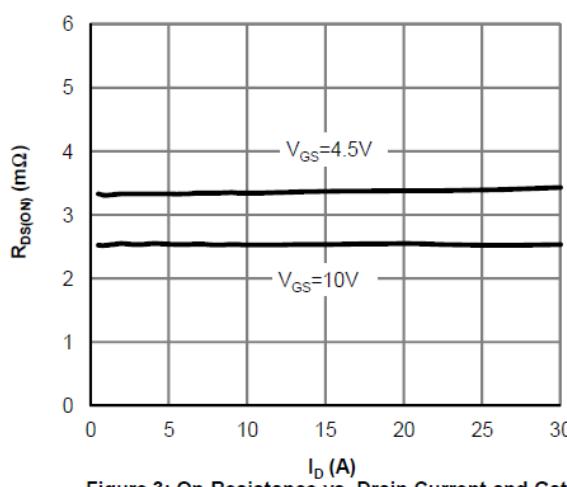


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

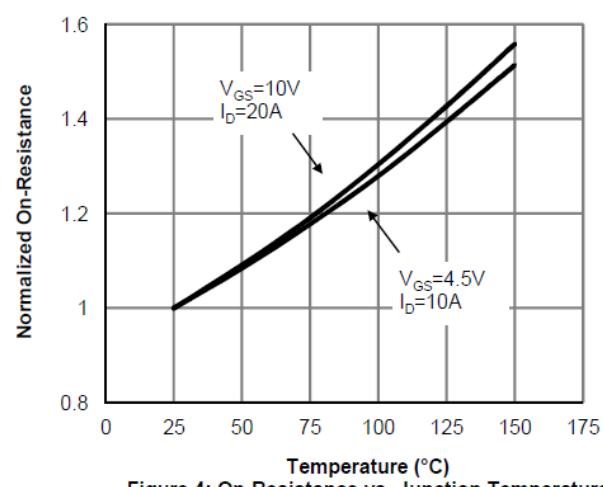


Figure 4: On-Resistance vs. Junction Temperature

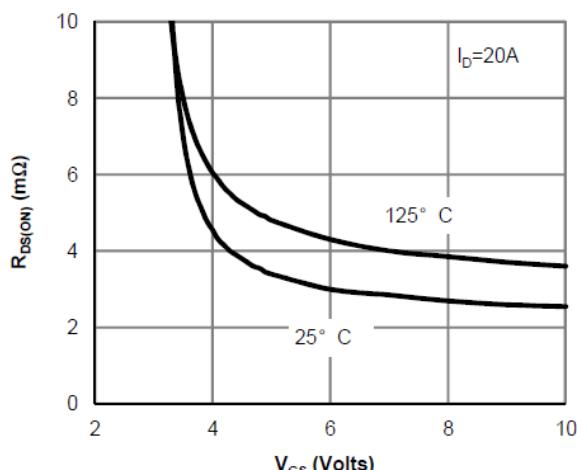


Figure 5: On-Resistance vs. Gate-Source Voltage

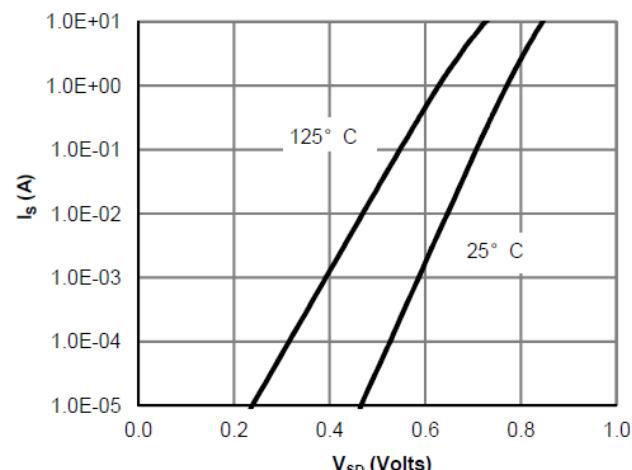
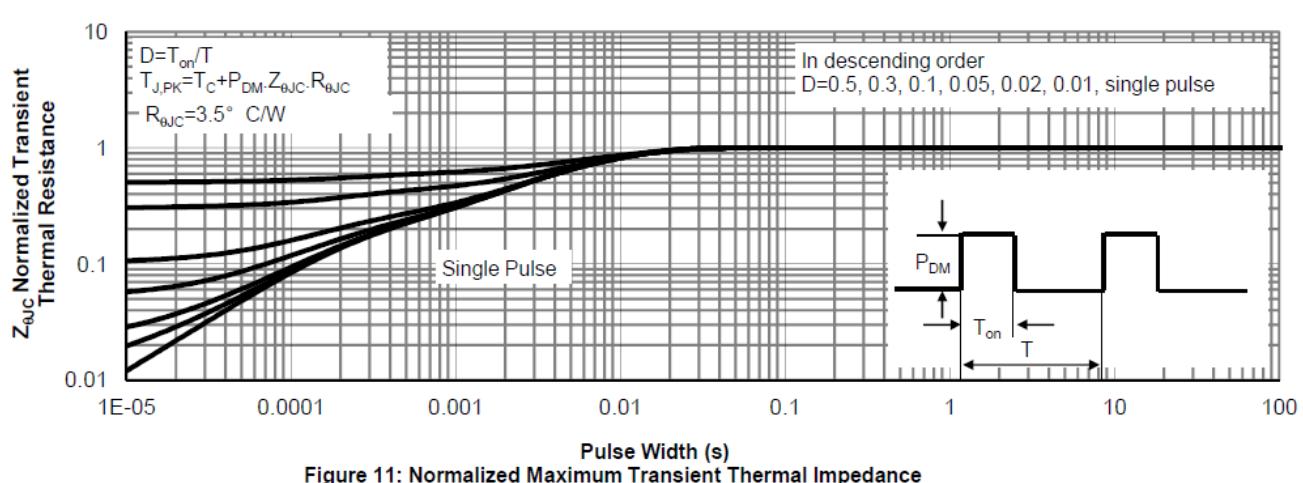
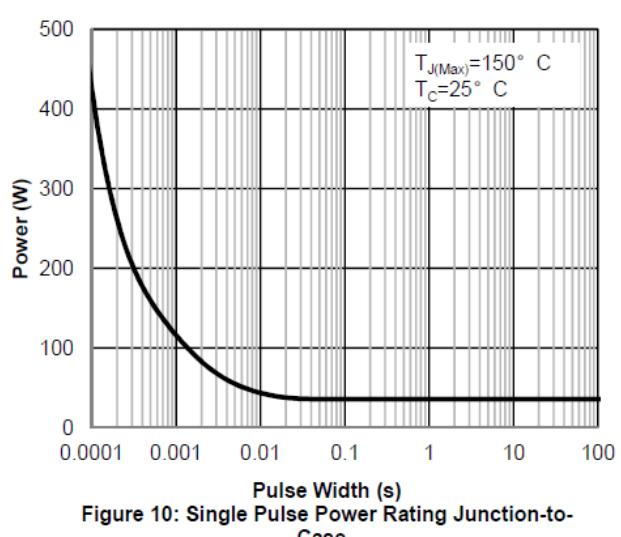
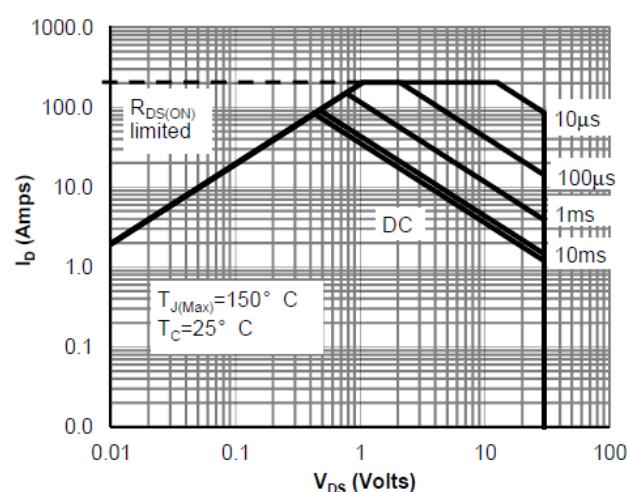
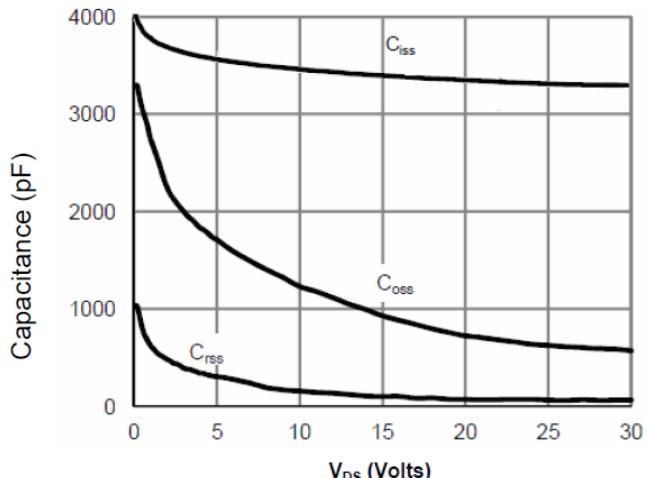
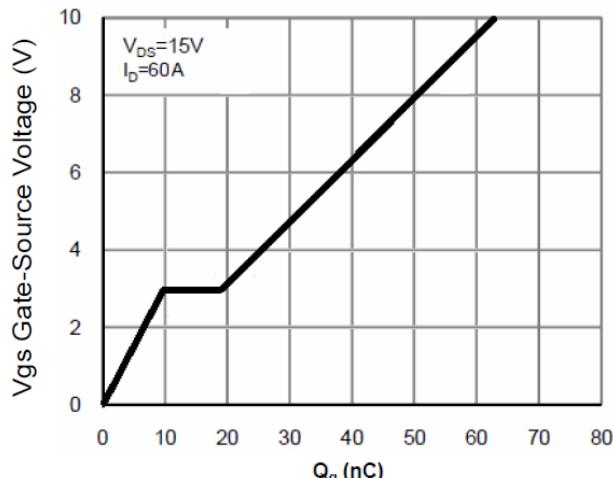
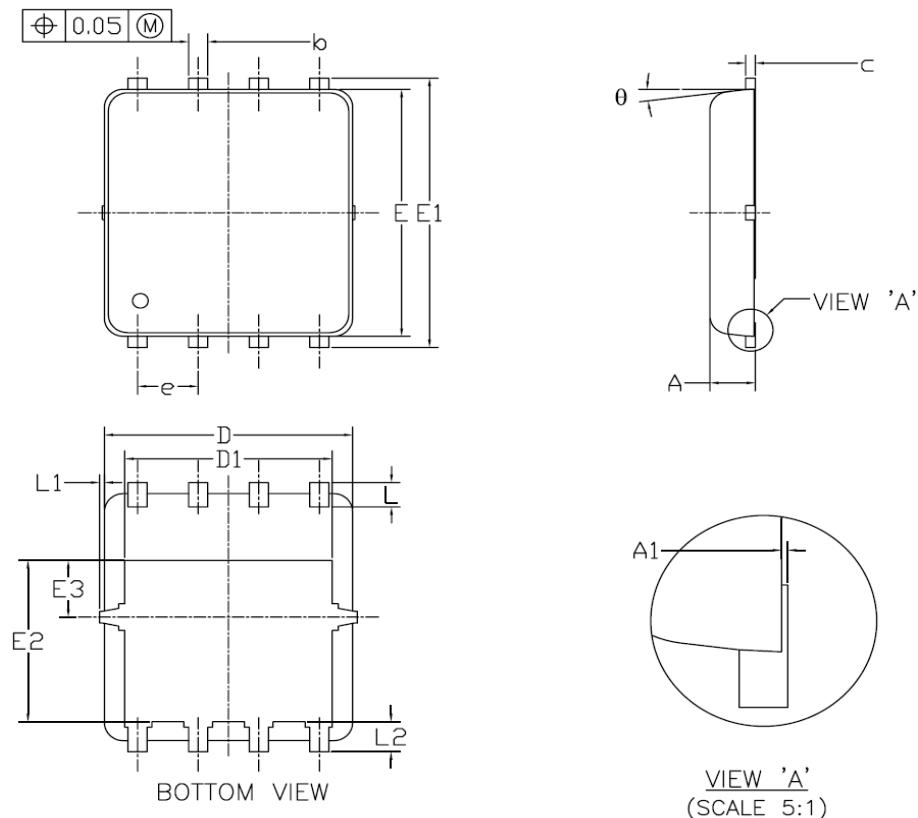
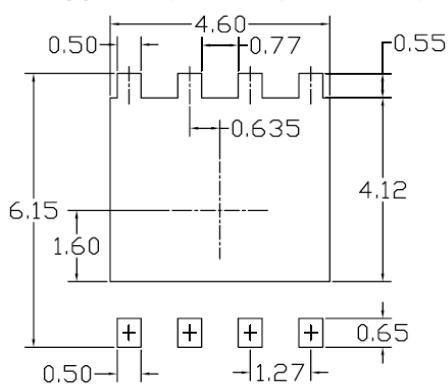


Figure 6: Body-Diode Characteristics



- **Package Information**


**RECOMMENDED LAND PATTERN**


SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.85	0.95	1.00	0.033	0.037	0.039
A1	0.00	—	0.05	0.000	—	0.002
b	0.30	0.40	0.50	0.012	0.016	0.020
c	0.15	0.20	0.25	0.006	0.008	0.010
D	5.20 BSC			0.205 BSC		
D1	4.35 BSC			0.171 BSC		
E	5.55 BSC			0.219 BSC		
E1	6.05 BSC			0.238 BSC		
E2	3.625 BSC			0.143 BSC		
E3	1.275 BSC			0.050 BSC		
e	1.27 BSC			0.050 BSC		
L	0.45	0.55	0.65	0.018	0.022	0.026
L1	0	—	0.15	0	—	0.006
L2	0.68 REF			0.027 REF		
$\theta$	0°	—	10°	0°	—	10°

**NOTE**

1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.  
MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6 MILS EACH.
2. CONTROLLING DIMENSION IS MILLIMETER.  
CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.

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